

# **The Fortronic LED& Lighting Design Forum**

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elementiu

# **Presentation for** *The Fortronic LED& Lighting Design Forum*

#### Things you hear about LEDs?

#### **Basic Advantages of LED Light:**

- Are very energy efficient
- Are directional No wasted light, any pattern possible
- Have very long lifetime
- Are inherently rugged No filament to break
- Start instantly controllable : New lighting features, power savings
- Are environmentally sound no Hg, Pb, heavy metals
- Love cold temperatures No cold starting issues

But .						
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The performance will depends on the design of the Light fixture



# The Fortronic LED& Lighting Design Forum

# Lighting Class LED's for High Quality LED Lighting

#### Topics:

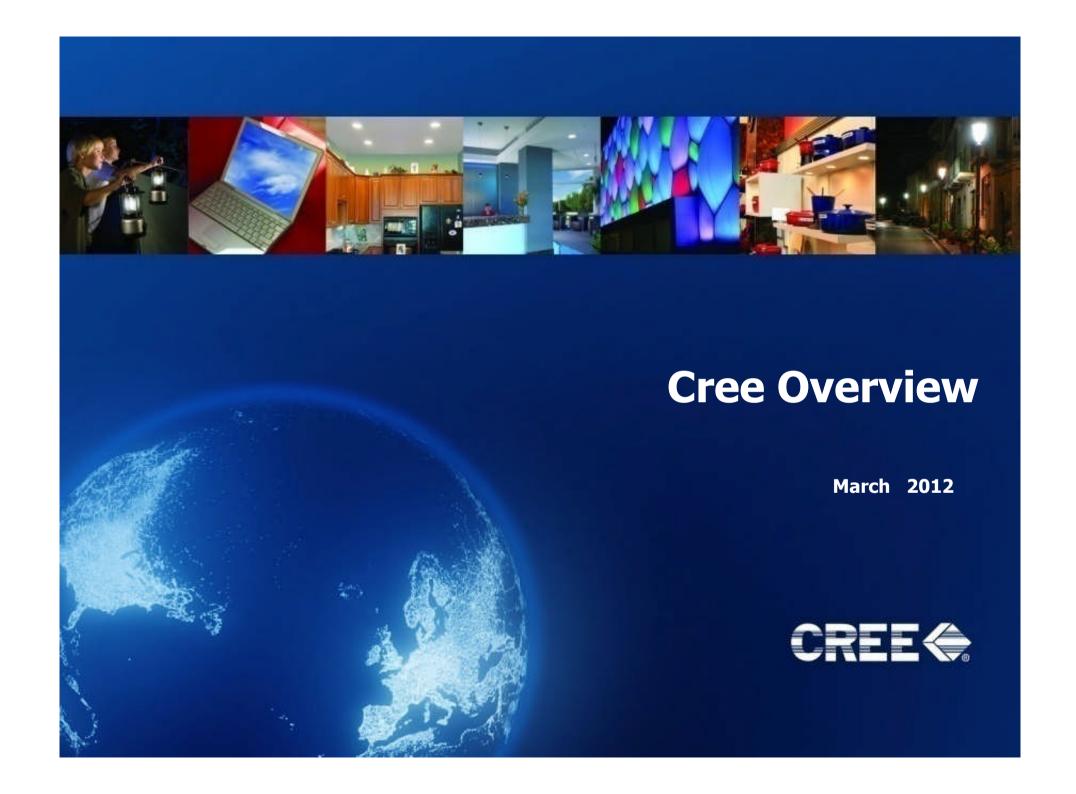
Introduction – an overview of Cree

Section 1 : Lighting Class LEDs

Section 2: High Quality LED Lighting – How to achieve

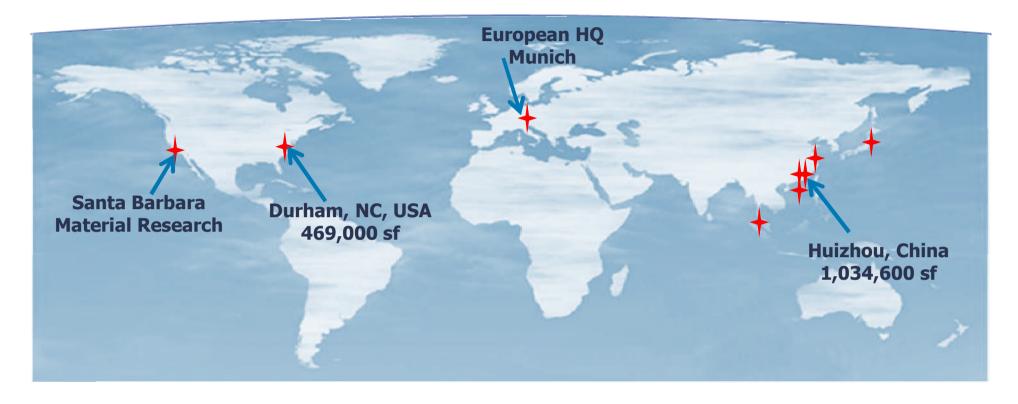
Section 3: Design and Handling considerations







# **Cree – A Global Company**



- US : Chip manufacturing
- China: Cree factories for high volume production
  - Manufacturing

- Regional Application and technology Centres
- Global and regional Distributors for local stock & service

#### Value of the Cree Brand



Nearly 9 out of 10 lighting buyers would be more likely to purchase products labeled "Cree LED inside"

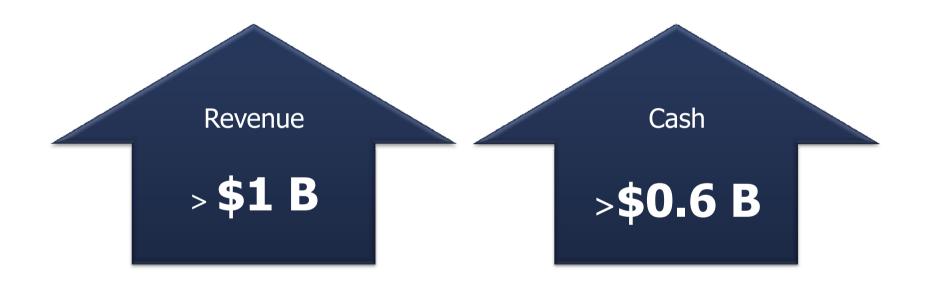
Perceived as higher quality

Cree recognized by IMS Research as the market leader in LEDs for lighting (Dec 2010)



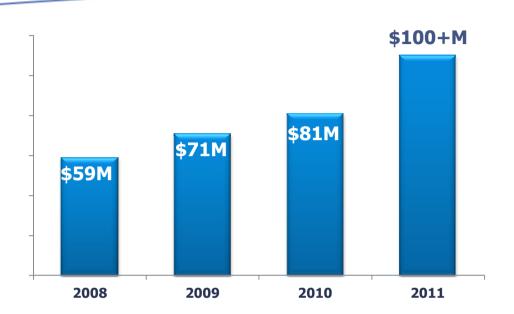


# **Financial Strength & Sustainability**

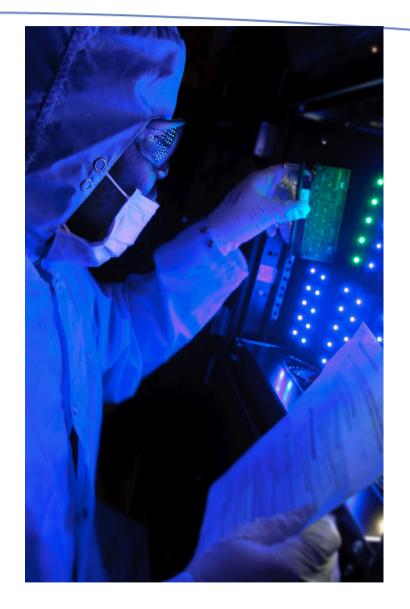




# **Investment in R&D – Driving Innovation**



- Advancements in lumens & lumens per Watt
- Larger wafers
- Reliability enhancements
- Optimized packages for lighting





# **Proof of Technology Leadership**



	Issued Patents	Pending Applications
U.S.	546	599
Non-U.S.	1,005	1,543
Total	1,551	2,142

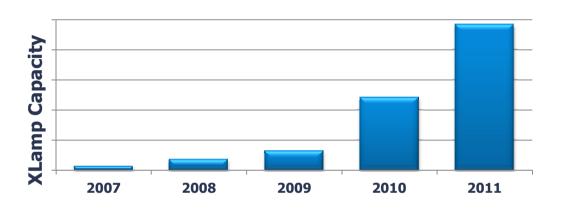
Note: All totals include exclusively licensed patents

 IP portfolio & scale large enough to provide indemnity that matters



# Investment - high volume production & cost down

#### High volume production



\$475M invested into capacity expansion over 3 years

#### Cost reductions

Larger Wafers - Creates Cost Reductions
Improvements in Flux / Efficacy – need less LEDs
Low cost manufacturing; high volumes – lower unit cost

 Year on Year savings passed on to customers



## The Fortronic LED& Lighting Design Forum

# Lighting Class LED's for High Quality LED Lighting

Topics:

Section 1 : Lighting Class LEDs

Section 2: High Quality LED Lighting - How to achieve

Section 3: Design and Handling considerations

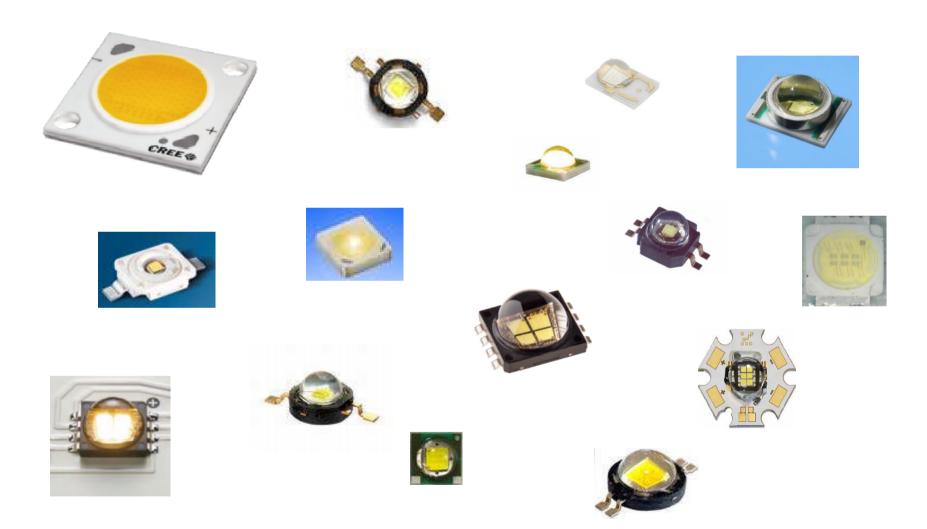


# **Lighting Class LED's** - What are they?





# **Lighting Class LED's** - What are they?





# **Lighting-Class LEDs are Not One Product**



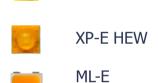


# **XLamp LEDs and Modules Portfolio: Lighting**

# Discretes (Directional) XR-E XR-C XP-G XP-G XP-C XP-C XB-D XT-E WHT



# Discretes (Non-Directional) XM-L HVW



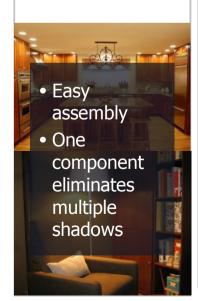




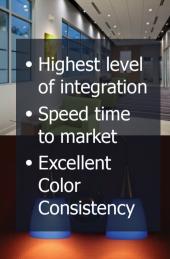














# What Can Go Wrong: Poor quality LEDs

Time zero



LED Puck 84.1% Drop



16.5" Linear 97.8% Drop



22" Linear 96.9% Drop

1000 hours

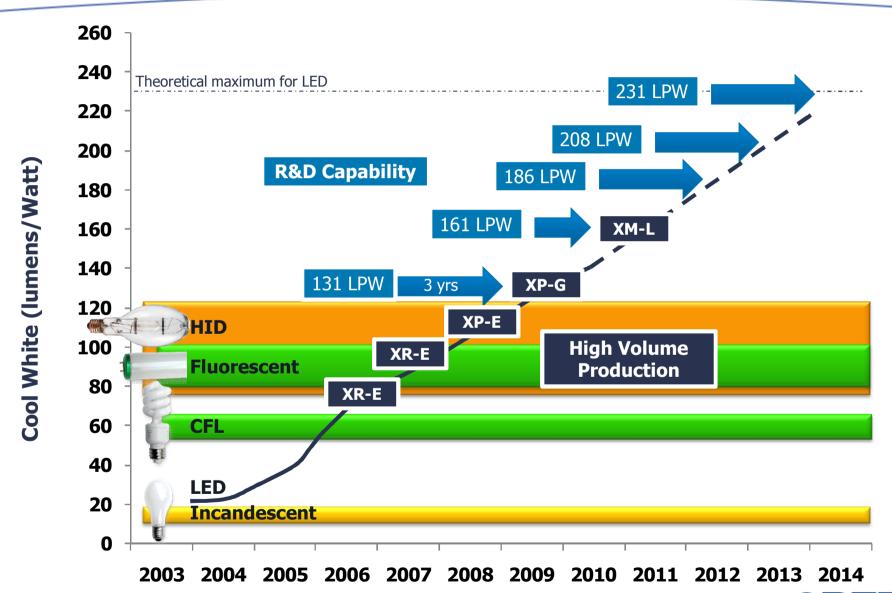








# **Lighting Class LED Efficacy Developments**



# **Cree Silicon Carbide Enables Next GEN Lighting Class LED**



Cree's newest SiC-based LED (shown in Royal Blue for better detail of the chip)

#### **Best Performance**

#### **Compared to sapphire:**

- Fewer dislocations → More photons
- Better index matching of GaN to substrate
  - → More light extraction
- → Inherent 5-10% efficacy advantage

#### **Best Reliability**

- Fewer epi defects
  - → Fewer LED failures & less rework

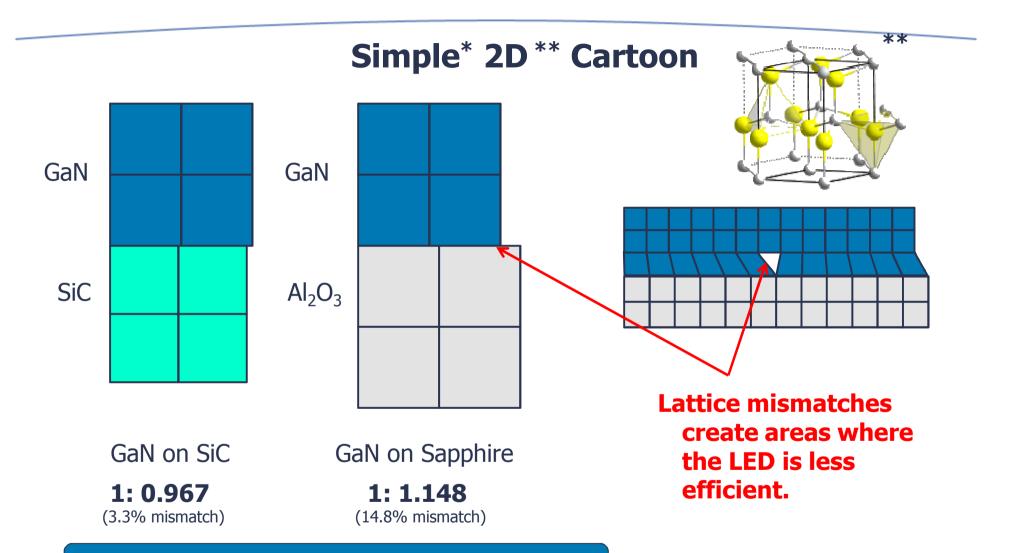
#### **Security of Supply**

- Only manufacturer of wafers AND chips
- → Ability to scale production quickly

SiC brings improvements optimized for lumens/\$



#### **Silicon Carbide Creates More Efficient LEDs**



#### **SiC = 4.5x better lattice match to GaN**



<sup>\*</sup> Drawn to scale.

<sup>\*\*</sup> SiC, GaN, and Al<sub>2</sub>O<sub>3</sub> are actually 3D Hexagonal crystalline structures

# **Lighting Class LED's** - **Need for Quality**

#### **LED Chip**

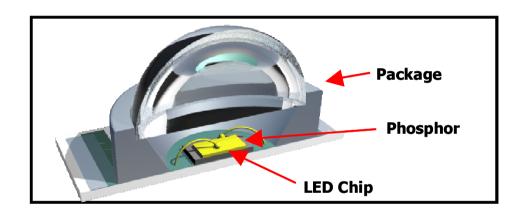
**Determines raw** brightness and efficacy

#### **Phosphor System**

**Determines color point and** color point stability

#### **Package**

- **Protects the chip and** phosphor
- **Helps with light and heat** extraction
- **Primary in determining LED** lifetime





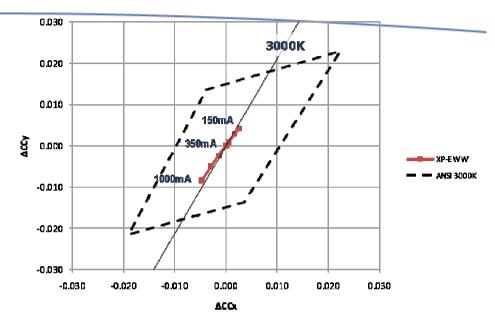
# **Lighting Class LED's**

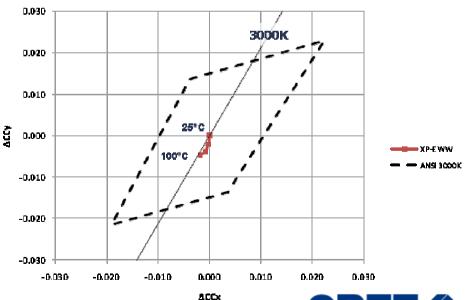
Colour stability



## **Color Shift in Operation (XP-E, Correlation Document)**

- Here the shifts are shown in X-Y space over the range of temperature and current
- These results are shown in detail in CLD AP81 rev 0, describing the correlation of measurements



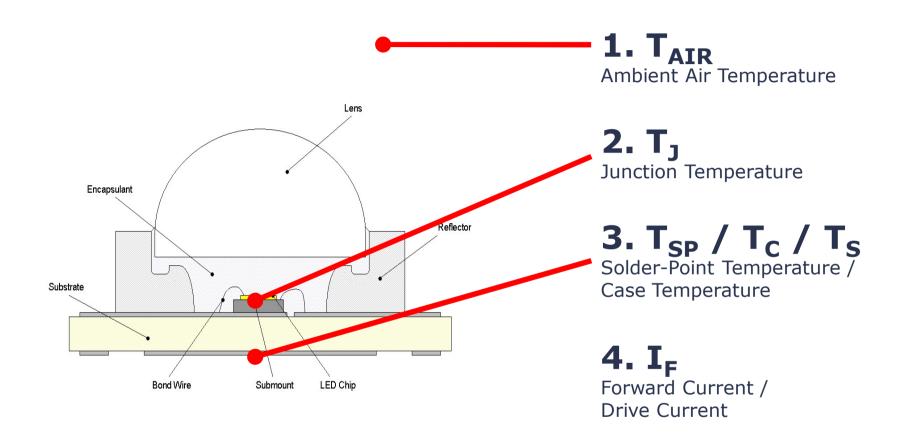


# **Lighting Class LED's**

• Lumen Maintenance - Life Time
L70

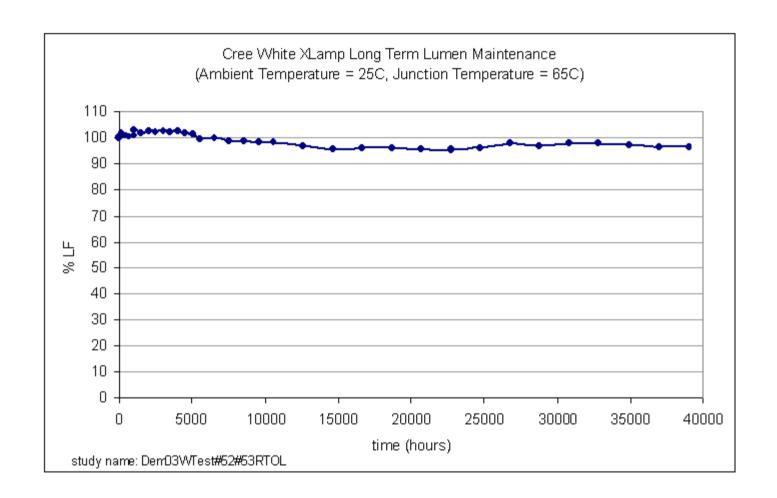


#### **LED Lumen Maintenance Critical Parameters**





# 40,000 Hour / 4.5 Year XLamp Long-Term Data



At lower ambient air temperature, LEDs hardly depreciate at all.



# **Lighting Class LED's**

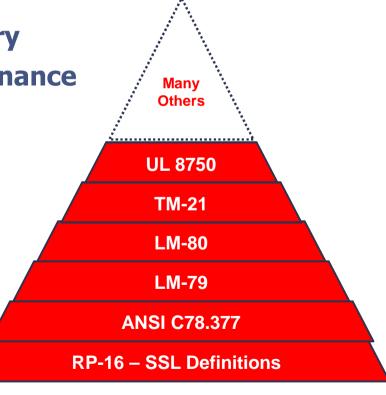
• Industry Standards



# **SSL Standards (U.S.)**

- 4 years ago: Major and reasonable objection to LED
- Today:
  - TM-21 Projecting Long Term Lumen Maintenance of LED Light Sources
  - ANSI C78.377 chromaticity
  - IES LM-79-2008 SSL photometry
  - IES LM-80-2008 Lumen Maintenance
  - UL 8750 Safety
  - RP-16 SSL Definitions
- Most of the major pieces are in place, many more on the way...
- Being practiced and referenced widely by industry and government programs







# **Lighting Class LED's**

## **Lighting-Class Performance:**

- High efficacy ( >80lm/w )
- Colour stability
- Lumen Maintenance
- Conform to industry standards



## The Fortronic LED& Lighting Design Forum

# Lighting Class LED's for High Quality LED Lighting

#### Topics:

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#### **LED Lifetime Is Irrelevant**

### **System Lifetime is What Creates Value**

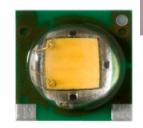
Heat Sink: Linchpin of the entire system. If this is poorly designed, all the other components can be compromised

<u>Driver</u>: Currently the weakest point of the system, but the big companies are working on this



<u>LED Lamps</u>: Practically never fail; depreciate very slowly in a well-designed system



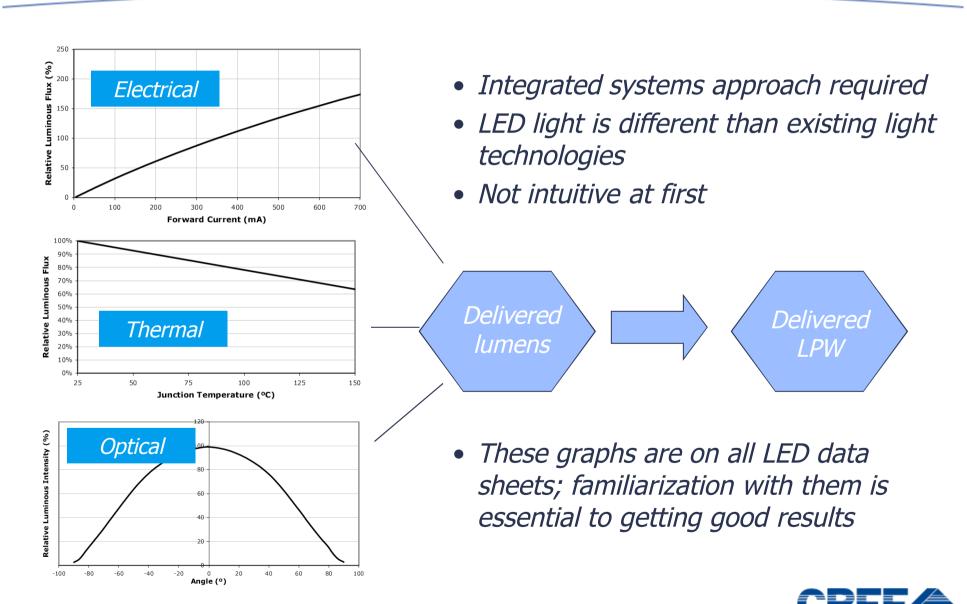


#### <u>Optical</u> <u>Components</u>

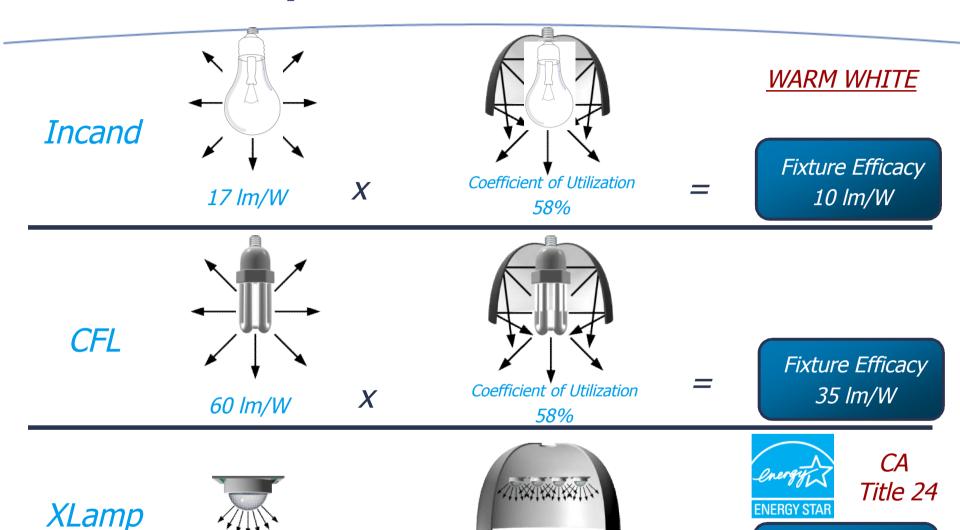
: Can (rarely) yellow over time and lose light; system design choice



# **SSL Luminaire: Multi-Disciplinary Effort**



# **Fixture Efficacy**



80 lm/W



Coefficient of Utilization Driver Efficiency Thermal Equilibrium

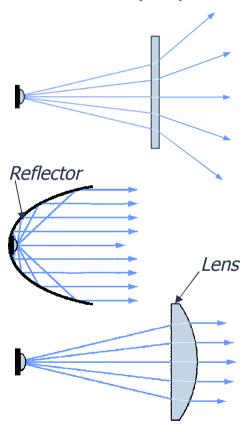
90% 91% **=** 88%\* Fixture Efficacy 56 lm/W



<sup>\*</sup> Including loss for thermal equilibrium @  $Tj = 65^{\circ}$  C

# **Typical Optical Losses**

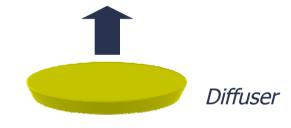
Secondary Optics



80%-90% Efficient

Diffuser/Glass



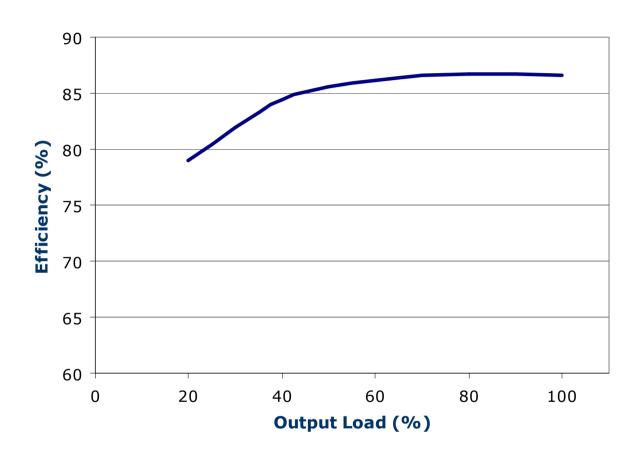




60%-90% Efficient



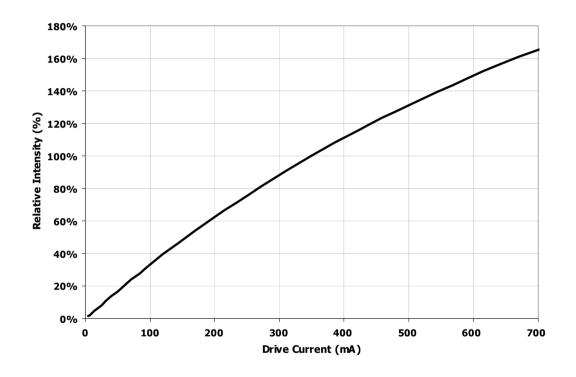
# **Typical Driver Losses**



Generally, 80% - 85% is a good estimate – but some will claim MUCH higher

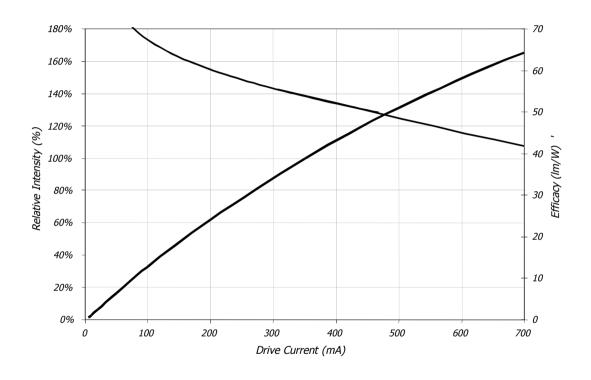


# **Iterative Process:** More Power = More Light...





## ...But More Power = Lower Efficacy (Droop)





## **Many Opportunities For Optimization**

I <sub>F</sub> (mA)	700	500	300
LPW	47	57	64
# of LEDs	18	22	34
Cost	\$	\$+	\$\$

There is often an opportunity to trade-off drive current ( $I_F$ ) and thermal design for both system LPW (efficacy) and overall system cost



## **High Quality LED Lighting**

- •To achieve a high quality LED lighting design
- Keys to success
  - Lighting-class LEDs
  - Thermal design
  - Optical design
  - Electronic design
- •Integrated System!!

Luminaire Design				
	Good	Bad		
Quality of LED Good	Excellent	BAD		
Quali Bad	BAD	BAD		

Results



## The Fortronic LED& Lighting Design Forum

# Lighting Class LED's for High Quality LED Lighting

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## **Design and Handling considerations**

Some examples of aspects that must be considered –

Chemical compatibility
Thermal Design
Electrical over stress



## Failure causes and modes due to bad handling

- Several times LEDs failed on the field before the expected life time
- Failures modes were graded by order of occurrence due to....



**Chemicals** 



**Electrical Over Stress EOS** 

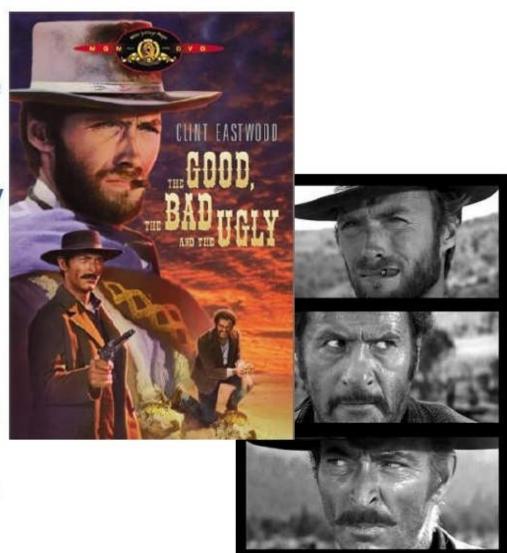


Thermal



## **Chemical compatibility**

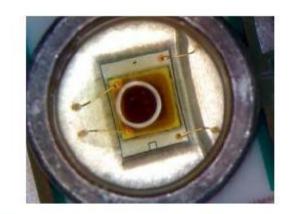
- There are good chemicals, and there are bad ones. Some are even ugly.
- Chemical incompatibility is generally more localized than "natural" silicone degradation.
- There are known molecules and families that are known to cause issues
- But there is nothing like testing!





## Symptoms of material incompatibility

- The volatile hydrocarbons will cause the encapsulant to discolor (turn brown) and block light emitted from the LED
- Factors that affect discoloration:
  - ✓ Heat
  - ✓ Photonic Energy
  - √ Wavelength



 The discoloration normally occurs at the top surface of the LED chip

ALL HIGH POWER LED LAMPS EXHIBIT THIS PHENOMENA

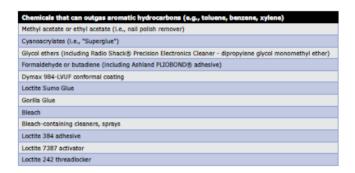


## **Material Compatibility**

- Application note on cree.com
- Shows example compatible and incompatible material as well as test method to determine compatibility



#### XLAMP CHEMICAL COMPATIBILITY



#### Selected Chemicals

In testing, Cree has found the following chemicals to be safe to use with XLamp LEDs.

Selected chemicals safe for use with XLamp LEDs
Water
Isopropyl alcohol (IPA)
Arctic Silver & Arctic Alumina brand thermal grease
3M Scotch-Weld epoxy adhesive DP-190 (polymeric diamante, kaolin)

#### Selected Conformal Coatings

In testing, Cree has found the following conformal coatings to be safe to use with XLamp LEDs. Conformal coating should not be applied directly to or over the LED lens, as this may affect LED optical performance and reliability.

Selected conformal coatings
Dow Coming 3-1953
Dow Coming 1-4105
Dow Coming 1-2577
Dymax 9-20557
Humiseal 1H20AR1/S
Humiseal UV40
Humiseal 1851NS
Humiseal 1873
Humiseal 1C49LV
Shat-R-Shield
Specialty Coating Systems - Parylene
TechSpray Turbo-Coat Acrylic Conformal Coating (2108-P)

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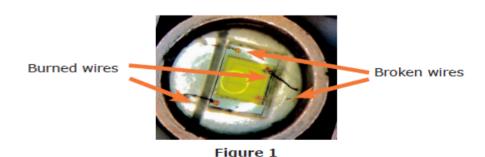
### **EOS – Electrical Over Stress**

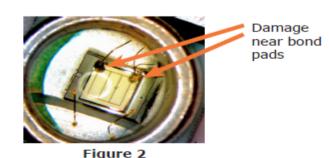
 Electrical over stress happens every time the maximum driving current is exceeded

 High current peak can destroy immediately the LED

 Low current peak above the maximum driving current can create damages that accelerate the LED dead

 No immediate failure doesn't mean the LED is still totally undamaged

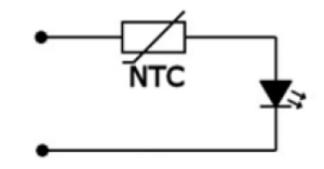


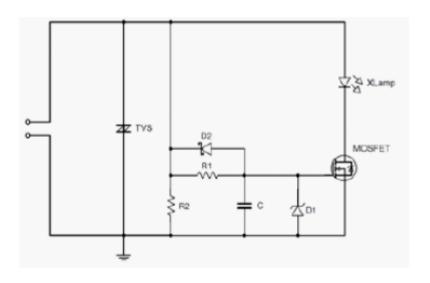




## **Prevention of Electrical Overstress**

- Drivers should be developed or selected to minimize this effect
- Passive, or better active, in-rush current protection can also be used to reduce or eliminate this effect







pq. 47

## **Thermal**



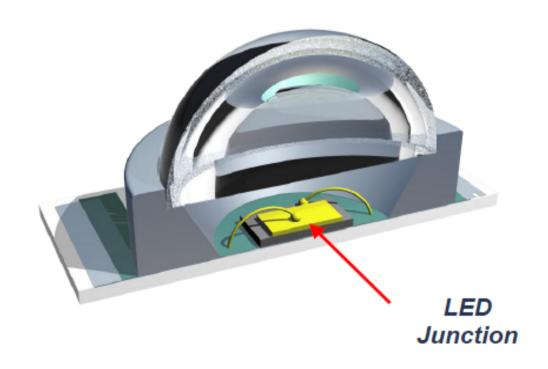
# **Good Design**

# **Bad Design**





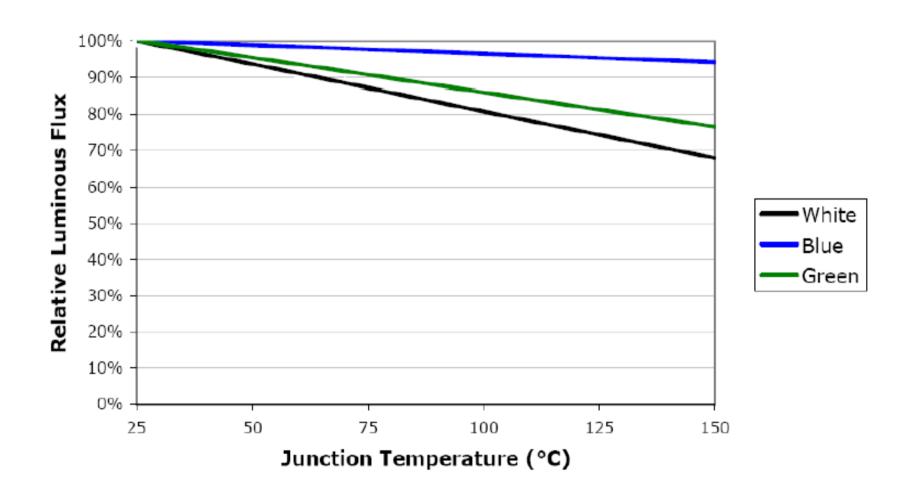
## Where Is the LED Junction?



- LED junction is located within the LED package
- LED junction temperature (Tj) cannot be measured directly



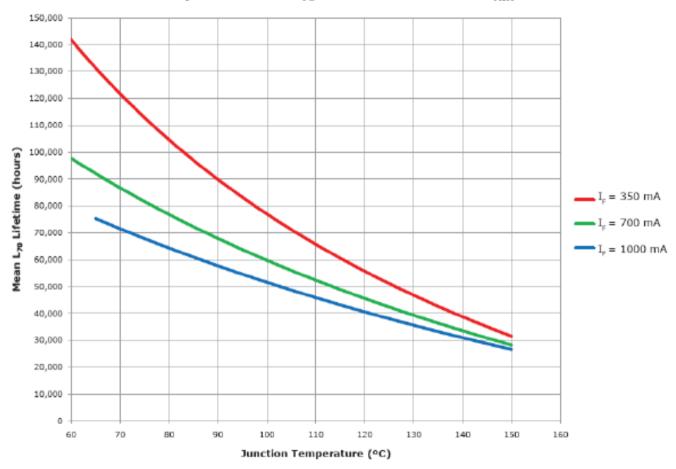
## Light output vs. Tj





## Lifetime vs. Tj

#### Cree XLamp XR-E White $L_{70}$ Lifetime Prediction - $T_{AIR} = 35$ °C





## Thermal issue origins

- Thermal pad not soldered
- Thermal pad not properly soldered
- LED functional test with standard driving current but without heat sink
- Poor thermal system



## Thermal – some definitive design information

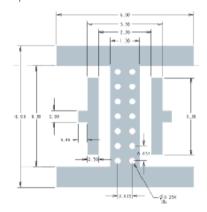
#### http://www.cree.com/products/pdf/XLamp PCB Thermal.pdf

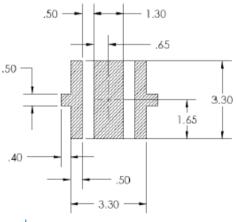


# Optimizing PCB Thermal Performance for Cree® XLamp® LEDs

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## **Examples of poor design**



## **Driver & Thermal Problems**



Driver/circuit board failure

• Color shift due to poor thermal design





## **Not a Binning Problem (Poor LED Selection)**

Time zero



LED Puck 84.1% Drop



**1000 hours** 



**16.5" Linear 97.8% Drop** 





**22" Linear 96.9% Drop** 

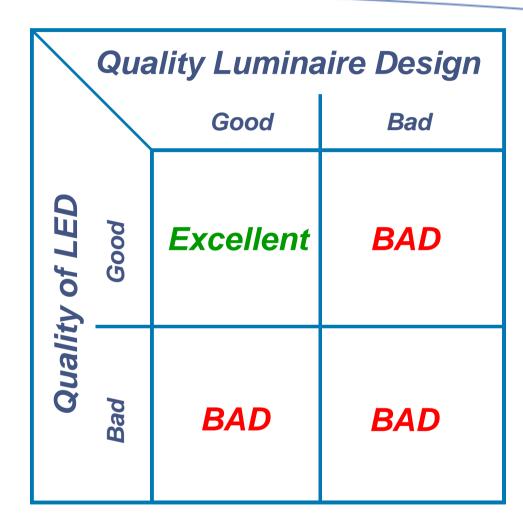




## **Summary: Quality Solid State Fixture Design**

Keys to success
 for High Quality
 SSL Fixtures:
 -Lighting-class LEDs
 and good...

- Thermal design
- Optical design
- Electronic design
- Handling



Results





#### **LED lighting: Energy efficient & planet friendly.**

#### **Cree. Leading the LED lighting revolution.**

Join Cree's LED lighting revolution. We invite you to see how our high-performance, high-efficiency LEDs are lighting up the world.

# THANK YOU

